

S2CD-THR 3.50/08/90LF 3.2SN BK BX

Weidmüller Interface GmbH & Co. KG

Klingenbergstraße 26

D-32758 Detmold

Germany

www.weidmueller.com

Product image



Similar to illustration

The new benchmark for component density: the virtual 0.875mm pitch - for 1mm² I/O connections

The only 4-row double level male connectors for standard IP20 sensor interfaces with 3.5 pitch

The S2L in a double pack - a standard has surpassed itself:

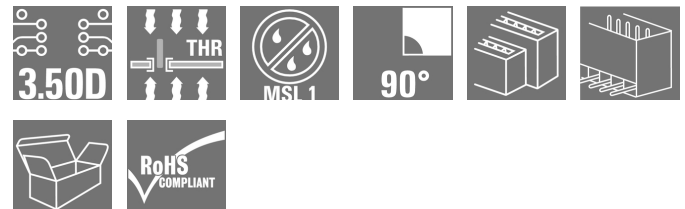
- Each 3.5mm wide, 4 I/O contacts for 1mm² connection cross-section
- Force-fit enclosure geometry guarantees maximum stability
- Solder flange eliminates the need for a screw fastening

Less is more - basic advantages for your applications:

- 75% space savings on the circuit board
- Solder flange reduces process costs
- Less mechanical load on the soldering points
- More space for displays in the front panel, for example

A "small" contribution to greater competitiveness:

additional features in the same installation space or a more compact device with the same range of functions.



General ordering data

Version	PCB plug-in connector, male header, closed side / solder flange, THT/THR solder connection, 3.50 mm, Number of poles: 8, 90°, Solder pin length (l): 3.2 mm, tinned, black, Box
Order No.	1357890000
Type	S2CD-THR 3.50/08/90LF 3.2SN BK BX
GTIN (EAN)	4050118160833
Qty.	50 pc(s).
Product data	IEC: 200 V / 7.9 A UL: 150 V / 9.5 A
Packaging	Box

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Technical data**Dimensions and weights**

Depth	24.4 mm	Depth (inches)	0.961 inch
Height	35 mm	Height (inches)	1.378 inch
Height of lowest version	31.8 mm	Net weight	6.86 g
Width	14 mm	Width (inches)	0.551 inch

System specifications

Product family	OMNIMATE Signal - series B2C/S2C 3.50 - 2-row	Type of connection	Board connection
Mounting onto the PCB	THT/THR solder connection	Pitch in mm (P)	3.5 mm
Pitch in inches (P)	0.138 inch	Outgoing elbow	90°
Number of poles	8	Number of solder pins per pole	1
Solder pin length (l)	3.2 mm	Solder pin dimensions	d = 1.0 mm, Octagonal
Solder eyelet hole diameter (D)	1.3 mm	Solder eyelet hole diameter tolerance (D) + 0,1 mm	
Outside diameter of solder pad	2.1 mm	Template aperture diameter	1.9 mm
L1 in mm	10.5 mm	L1 in inches	0.413 inch
Pin series quantity	2	Touch-safe protection acc. to DIN VDE 57 106	Safe from finger touch
Touch-safe protection acc. to DIN VDE 0470	IP 20	Can be coded	Yes

Material data

Insulating material	LCP GF	Colour	black
Colour chart (similar)	RAL 9011	Insulating material group	IIIb
Comparative Tracking Index (CTI)	≥ 175	Moisture Level (MSL)	1
UL 94 flammability rating	V-0	Contact material	Copper alloy
Contact surface	tinned	Layer structure of solder connection	1...3 µm Ni / 2...5 µm Sn matt
Layer structure of plug contact	2...5 µm Sn / 1...3 µm Ni	Storage temperature, min.	-40 °C
Storage temperature, max.	70 °C	Operating temperature, min.	-50 °C
Operating temperature, max.	120 °C	Temperature range, installation, min.	-40 °C
Temperature range, installation, max.	120 °C		

Rated data acc. to IEC

tested acc. to standard	IEC 60664-1, IEC 61984	Rated current, min. number of poles (Tu=20°C)	7.9 A
Rated current, max. number of poles (Tu=20°C)	5 A	Rated current, min. number of poles (Tu=40°C)	6.8 A
Rated current, max. number of poles (Tu=40°C)	5 A	Rated voltage for surge voltage class / pollution degree II/2	200 V
Rated voltage for surge voltage class / pollution degree III/2	160 V	Rated voltage for surge voltage class / pollution degree III/3	100 V
Rated impulse voltage for surge voltage class/ pollution degree II/2	2.5 kV	Rated impulse voltage for surge voltage class/ pollution degree III/2	2.5 kV
Rated impulse voltage for surge voltage class/ contamination degree III/3	1.5 kV	Short-time withstand current resistance	3 x 1s with 80 A

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Technical data**Rated data acc. to CSA**

Institute (CSA)



Certificate No. (CSA)

200039-1121690

Rated voltage (Use group B / CSA) 50 V

Rated voltage (Use group C / CSA) 50 V

Rated voltage (Use group D / CSA) 150 V

Rated current (Use group B / CSA) 5 A

Rated current (Use group C / CSA) 9.5 A

Rated current (Use group D / CSA) 9.5 A

Reference to approval values

Specifications are maximum values, details - see approval certificate.

Rated data acc. to UL 1059

Institute (cURus)



Certificate No. (cURus)

E60693

Rated voltage (Use group B / UL 1059) 150 V

Rated voltage (Use group C / UL 1059) 50 V

Rated voltage (Use group D / UL 1059) 50 V

Rated current (Use group B / UL 1059) 9.5 A

Rated current (Use group C / UL 1059) 9.5 A

Rated current (Use group D / UL 1059) 9.5 A

Reference to approval values

Specifications are maximum values, details - see approval certificate.

Packing

Packaging

Box

VPE length

32 mm

VPE width

134 mm

VPE height

195 mm

Classifications

ETIM 6.0

EC002637

ETIM 7.0

EC002637

ECLASS 9.0

27-44-04-02

ECLASS 9.1

27-44-04-02

ECLASS 10.0

27-44-04-02

ECLASS 11.0

27-46-02-01

Important note

IPC conformity

Conformity: The products are developed, manufactured and delivered according international recognized standards and norms and comply with the assured properties in the data sheet resp. fulfill decorative properties in accordance with IPC-A-610 "Class 2". Further claims on the products can be evaluated on request.

Notes

- Gold-plated contact surfaces on request
- Rated current related to rated cross-section & min. No. of poles.
- Spacing between rows: see hole layout
- P on drawing = pitch
- Rated data refer only to the component itself. Clearance and creepage distances to other components are to be designed in accordance with the relevant application standards.
- Long term storage of the product with average temperature of 50 °C and average humidity 70%, 36 months

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www.weidmueller.com**Technical data****Approvals**

Approvals



ROHS Conform

UL File Number Search E60693

DownloadsApproval/Certificate/Document of
Conformity[Declaration of the Manufacturer](#)

Engineering Data

[STEP](#)

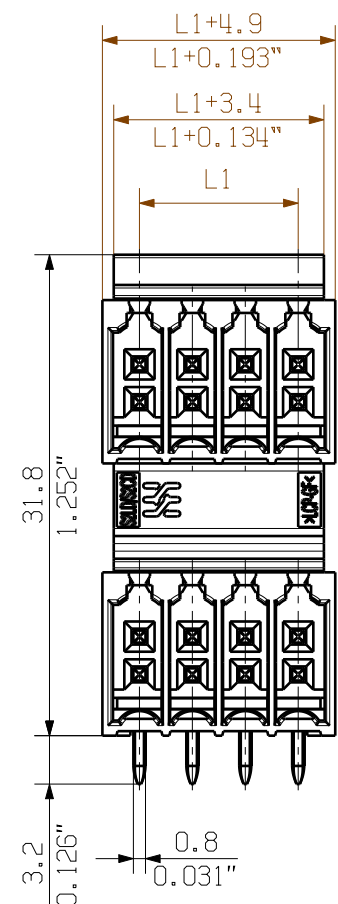
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Drawings

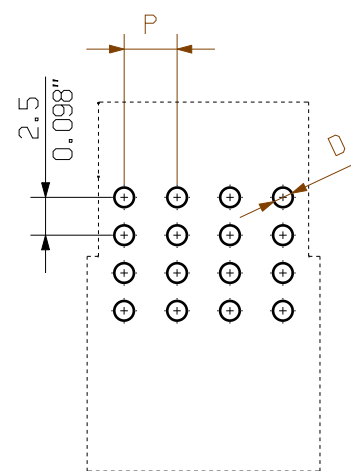
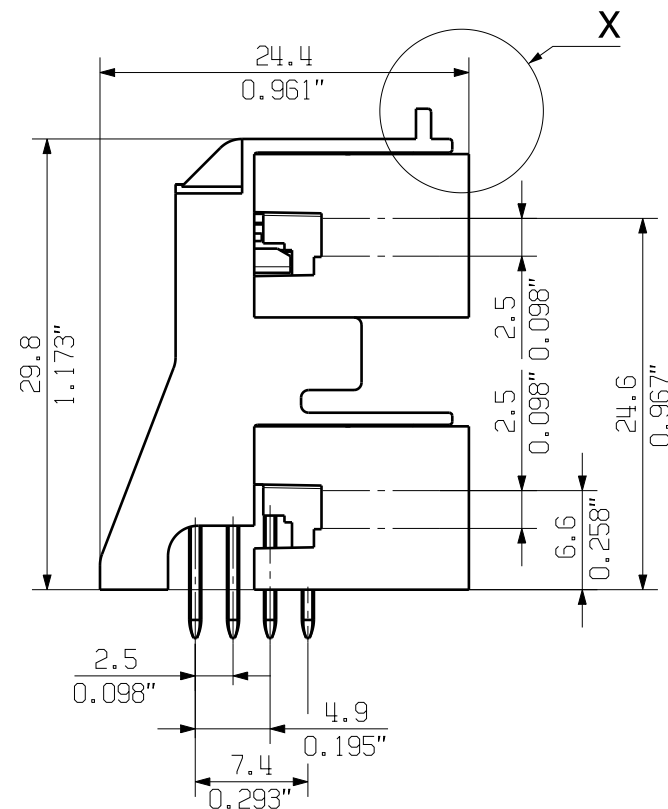
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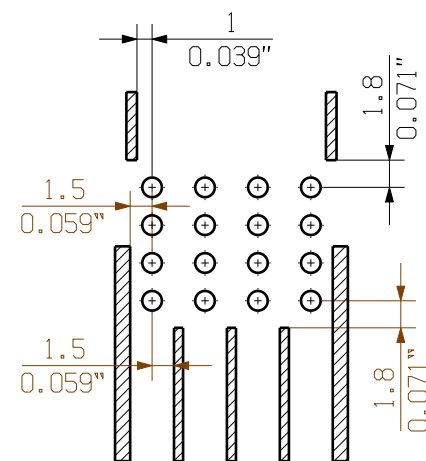
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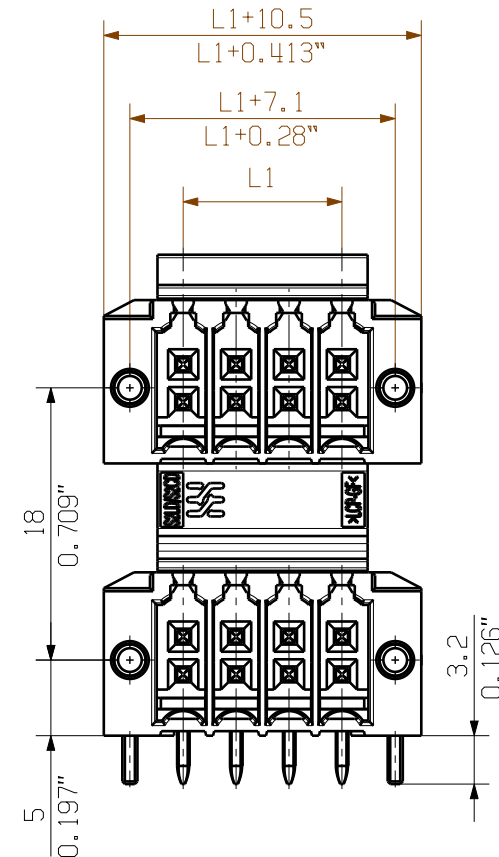
SHOWN: S2CD-THR 3.50/16/90G



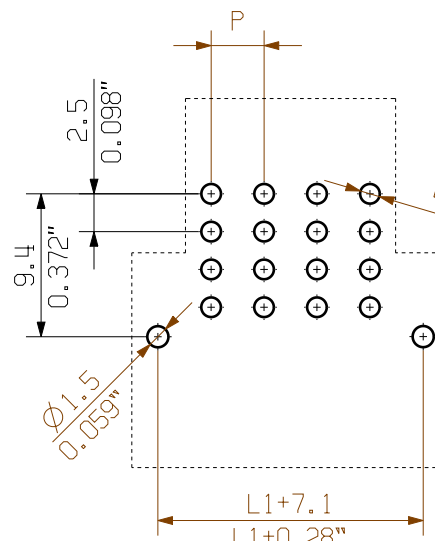
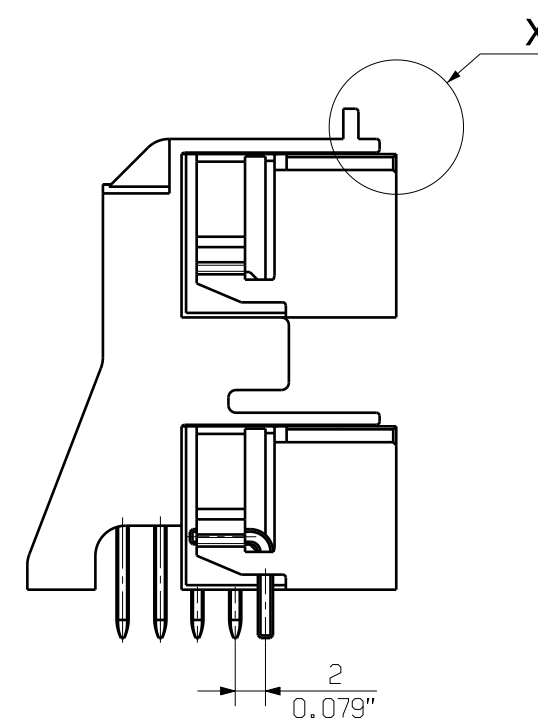
HOLE PATTERN



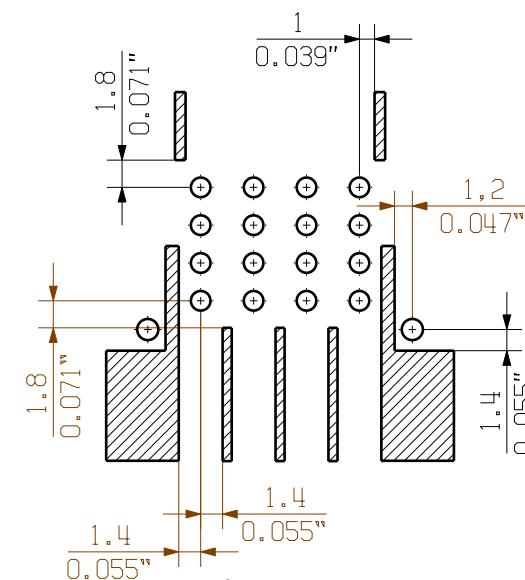
PASTE FREE AREA
MAX. DIMENSION



SHOWN: S2CD-THR 3.50/16/90LF



HOLE PATTERN



PASTE FREE AREA
MAX. DIMENSION

For the mounting of PCBs, it should be noted that the rated data relates only to the PCB components alone.

The necessary creepage and clearance paths must be observed in connection with the respective applicant in accordance to IEC 664 / VDE 0110.

The current-carrying capacity and pitch tolerance is to be determined according to DIN IEC 326 part 3 very fine.

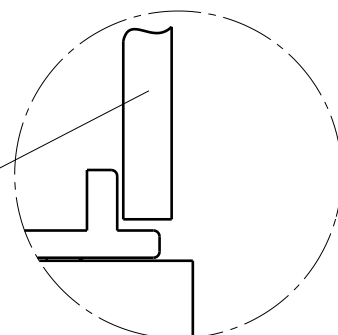
Weidmüller PCB components are tested to the DIN EN 61984 standard, and are valid for its field of application. Provided that the components are used to the intended purpose, all requirements with respect to the occurring of electrical, mechanical, thermic and corrosive stress will be satisfied.

	36	59.5	2.343
	32	52.5	2.067
	28	45.5	1.791
	24	38.5	1.516
	20	31.5	1.240
	16	24.5	0.965
	12	17.5	0.689
	8	10.5	0.413
II	n POLZAHL POLES	L1 [mm]	L1 [inch]

P = 3.50 RASTER
PITCH
D = Ø1.3 +0.1
0.051"
d = 0.8x0.8
0.031"x0.031"

ABSTUETZUNG ERFORDERLICH
SUPPORT NECESSARY

BEI ALLEN VERSIONEN
FOR ALL VERSIONS



X 4/1
ACHTUNG
ATTENTION

GENERAL TOLERANCE:
DIN ISO 2768-m



74586/5	01
01.07.14 TIELKER S	

SCALE: 2/1

SUPERSEDES: .

	DATE	NAME
DRAWN	31.01.2013	FRIELING_L
RESPONSIBLE		APORIUS_S
CHECKED	07.07.2014	HELIS_MA
APPROVED		HANKE_D

Weidmüller 

CAT.NO.:
C 55770 **01**
 DRAWING NO. ISSUE NO.
 SHEET 01 OF 01 SHEETS

S2CD-THR 3.50/.../90
STIFTELEISTE
MALE HEADER

PRODUCT FILE: B2CF/S2C

7400

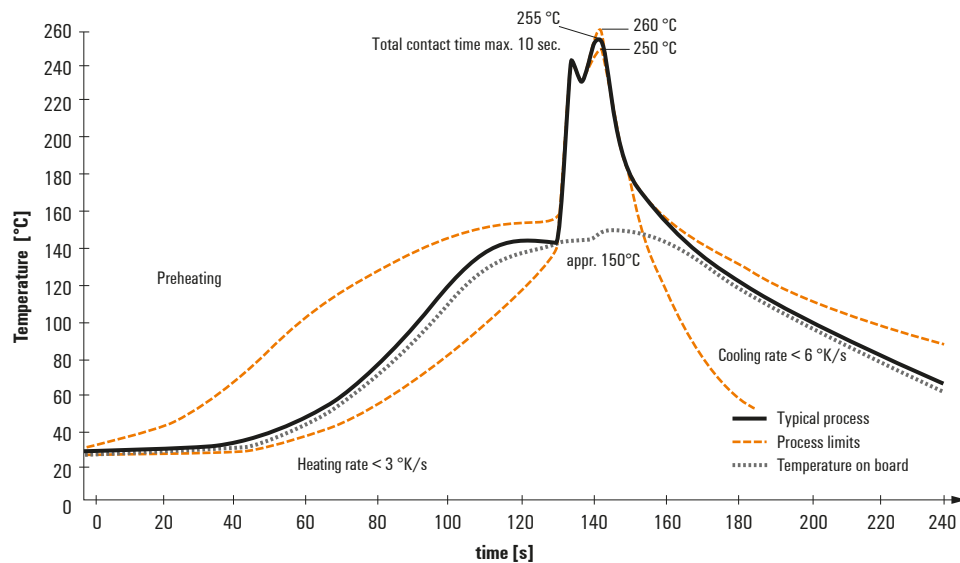
Recommended wave soldering profiles

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Single Wave:



Double Wave:



Wave soldering profiles

Wired connection elements should be processed in accordance with the DIN EN 61760-1 standard. We have included two recommendations for practical wave soldering profiles, with which Weidmüller PCB terminals and connectors are qualified.

When choosing a suitable profile for your application, the following factors also need to be considered:

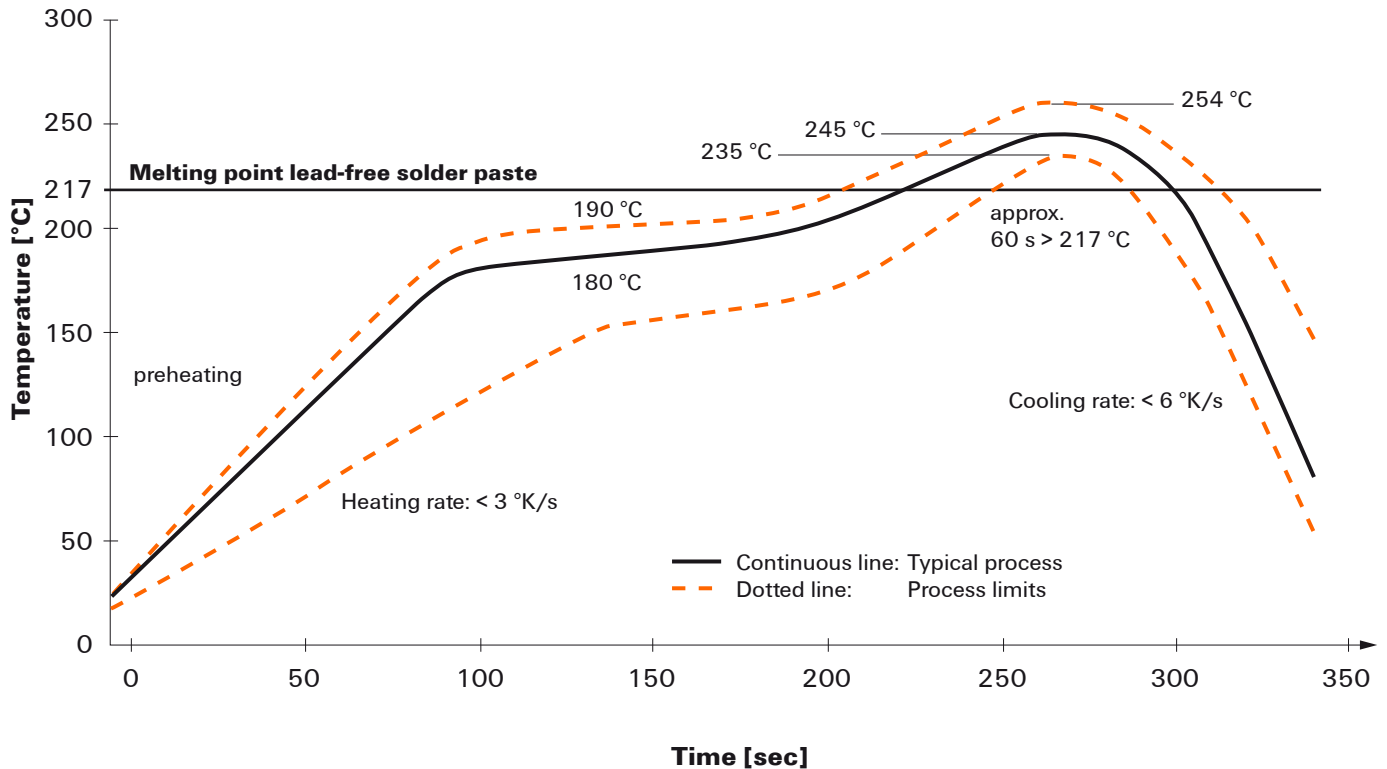
- PCB thickness
- Proportion of Cu in the layers
- Single/double-sided assembly
- Product range
- Heating and cooling rates

The single and double wave profiles each indicate the recommended operating range, including the maximum soldering temperature of 260°C. In practice, the maximum soldering temperature is quite often well below the above maximum profile.

We reserve the right to make technical changes.

Recommended reflow soldering profile

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Reflow soldering profile

The perfect soldering profile for SMT Surface Mount Technology is one the most exiting question in SMT production. But there are more than one correct answer: The diagram of temperature-on-time is related to processing features of solder paste and to maximum load of components.

We have to consider the following parameters:

- Time for pre heating
- Maximum temperature
- Time above melting point
- Time for cooling
- Maximum heating rate
- Maximum cooling rate

We recommend a typical solder profile with associated process limits. With preheating components and board are prepared smoothly for the solder phase. Heating rate is typically $\leq +3\text{K/s}$. In parallel the solder paste is 'activated'. The time above melting point of 217°C the paste gets liquid and components and boards begin to connect. The maximum temperature of 245°C to 254°C should stay between 10 and 40 seconds. In the cooling phase at $\geq -6\text{K/s}$ solder is cured. Board and components cool down while avoiding cold cracks.